

PC3SF21YVZ Series

*Non-zero cross type is also available. WWW (PC3SF11YVZ Series)

V_{DRM} : 600V, Reinforced insulation type Zero cross type **DIP 6pin** Phototriac Coupler for triggering



Description

PC3SF21YVZ Series reinforced insulation type Phototriac Coupler include an infrared emitting diode (IRED) optically coupled to an output Phototriac.

These devices feature full wave control and are ideal isolated drivers for medium to high current Triacs.

DIP package provides 5.0kV isolation from input to output with superior commutative noise immunity.

Features

- 1. High repetitive peak off-state voltage (V_{DRM} : 600V)
- 2. Zero crossing functionality (Vox : MAX. 20V)
- 3. IFT ranks available (see Model Line-up section in this datasheet)
- 4. 6 pin DIP package
- 5. Reinforced insulation type (MIN. 0.4mm internal separation)
- 6. Superior noise immunity (dV/dt : MIN. 1 000V/µs)
- 7. Lead-free components are also available (see Model Line-up section in this datasheet)
- 8. Double transfer mold construction (Ideal for Flow Soldering)
- 9. High isolation voltage between input and output $(V_{iso}(rms) : 5.0kV)$

Agency approvals/Compliance

- 1. Recognized by UL1577 (Double protection isolation), file No. E64380 (as model No. 3SF21)
- 2. Approved by CSA, file No. CA95323 (as model No. 3SF21)
- 3. Approved by BSI : BS-EN60065, file No. 6690/BS-EN60950, file No. 7421, (as model No. 3SF21)
- 4. Approved by SEMKO, EN60065/EN60950, file No. 0033029 (as model No. 3SF21)
- 5. Approved by DEMKO, EN60065/EN60950, file No. 310107 (as model No. 3SF21)
- 6. Approved by FIMKO, EN60065/EN60950, file No. 15795 (as model No. 3SF21)
- 7. Approved by VDE (*)(DIN EN 60747-5-2), file No. 40008189 (as model No. 3SF21)
- 8. Package resin : UL flammability grade (94V-0)

(*) DIN EN60747-5-2 : successor standard of DIN VDE0884 Up to Date code "RD" (December 2003), approval of DIN VDE0884. From Date code "S1" (January 2004), approval of DIN EN60747-5-2.

Applications

1. Triggering for Triacs used to switch on and off devices which require AC Loads.

For example heaters, fans, motors, solenoids, and valves.

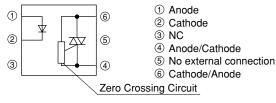
2. AC line control in power supply applications.

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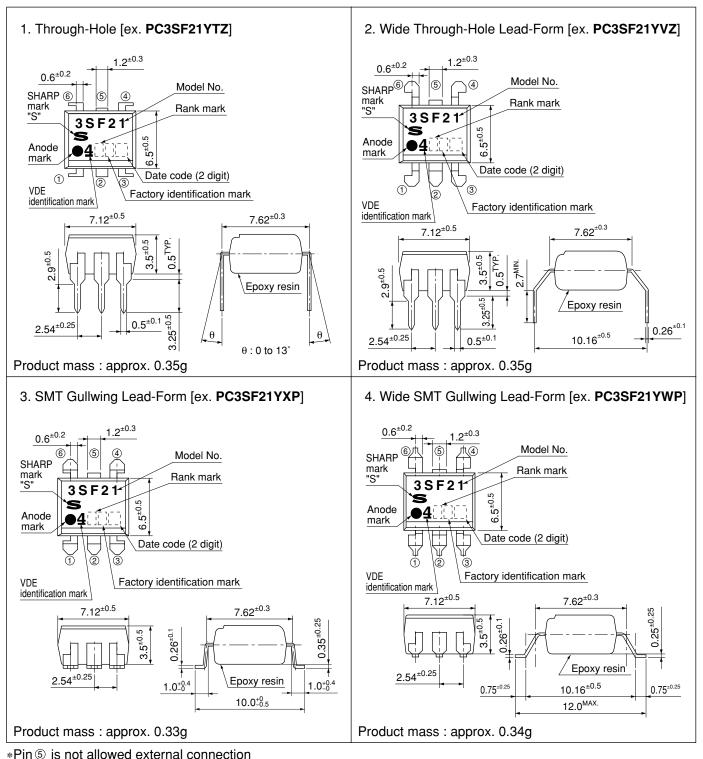
Internal Connection Diagram



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Outline Dimensions

(Unit : mm)



www.DataSheet411.com



Date code (2 digit)

		1st o	digit		2nd	digit			
-		Year of p	roduction		Month of production				
	A.D. Mark A.D			Mark	Month	Mark			
	1990	А	2002	Р	January	1			
	1991	В	2003	R	February	2			
www.c	1992 datasheet4i	C	2004	S	March	3			
	1993	D	2005	Т	April	4			
	1994	Е	2006	U	May	5			
	1995	F	2007	V	June	6			
	1996	Н	2008	W	July	7			
	1997	J	2009	Х	August	8			
	1998	K	2010	А	September	9			
	1999	L	2011	В	October	0			
	2000	М	2012	С	November	Ν			
	2001	N			December	D			

repeats in a 20 year cycle

Factory identification mark

Factory identification Mark	Country of origin		
no mark	I		
	Japan		
	Indonesia		
$\overline{\nabla}$	Philippines		
	China		

* This factory marking is for identification purpose only.

Please contact the local SHARP sales representative to see the actural status of the production.

Rank mark

Refer to the Model Line-up table



PC3SF21YVZ Series

Absolute Maximum Ratings

	Absolute Maximum Ratings								
		Parameter	Symbol	Rating	Unit				
	T	Forward current	I _F	50	mA				
	Input	Reverse voltage	V _R	6	V				
		RMS ON-state current	I _T (rms)	0.1	А				
	Output	Peak one cycle surge current	I _{surge}	1.2 *3	А				
\\/\\/\\/	datashoo	Repetitive peak OFF-state voltage	V _{DRM}	600	V				
	*1 Isolati	on voltage	V _{iso} (rms)	5.0	kV				
	Operat	ting temperature	T _{opr}	-30 to +100	°C				
	Storage temperature			-55 to +125	°C				
	*2 Solder	ing temperature	T _{sol}	270 *4	°C				

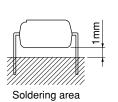
*1 40 to 60%RH, AC for 1minute, f=60Hz *2 For 10s

*3 f=50Hz sine wave

*4 Lead solder plating models: 260°C

■ Electro-optical Characteristics

	Electro-optical Characteristics $(T_a=25^{\circ}C)$									
	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit		
Tamut	Forward voltage		V _F	I _F =20mA	-	1.2	1.4	V		
Input	Reverse current		I _R	V _R =3V	-	-	10	μΑ		
	Repentitive peak OFF-state	current	I _{DRM}	$V_D = V_{DRM}$	-	-	1	μΑ		
	ON-state voltage		VT	I _T =0.1A	_	-	2.5	V		
Output	Holding current		I _H	V _D =4V	0.1	-	3.5	mA		
	Critical rate of rise of OFF-sta	ate voltage	dV/dt	$V_D = 1/\sqrt{2} \cdot V_{DRM}$	1 000	2 000	-	V/µs		
	Zero cross voltage		Vox	I _F =15mA, Resistance load	-	-	20	V		
	Minimum triagan aumont	Rank A	т	V 4V B 1000	-	-	10			
Transfer	Minimum trigger current	Rank B	I _{FT}	$V_D=4V, R_L=100\Omega$	_	-	7	mA		
charac- teristics	Isolation resistance		R _{ISO}	DC500V,40 to 60%RH	5×10 ¹⁰	1011	-	Ω		
	Turn-on time		t _{on}	$V_D=4V, R_L=100\Omega, I_F=20mA$	-	-	50	μs		





■ Model Line-up (1) (Lead-free components)

Lead Form	ead Form Through-Hole SMT Gullwing Wide Through-Hole							
Chinaine Declares					I _{FT} [mA]			
Shipping Package 50pcs/sleeve								$(V_D=4V,$
DIN		Annrouad		Approved		Approved		$R_L=100\Omega)$
EN60747-5-2		Approved		Approved		Approved		
www.datasheet4u.com Model No.		PC3SF21YTZAF		PC3SF21YXZAF		PC3SF21YVZAF	А	MAX.10
widdel no.		PC3SF21YTZBF		PC3SF21YXZBF		PC3SF21YVZBF	В	MAX.7

Lead Form	Wide SMT Gullwing		SMT Gullwing W		Wide SM'	Wide SMT Gullwing		
Chinaina Daalaaa	Sleeve			Ta		I _{FT} [mA]		
Shipping Package	50pcs/sleeve		1 000pcs/reel				Rank mark	$(V_D=4V,$
DIN EN60747-5-2		Approved		Approved		Approved		$R_L=100\Omega$)
Model No.		PC3SF21YWZAF		PC3SF21YXPAF		PC3SF21YWPAF	А	MAX.10
widdel No.	· · · · · · · · · · · · · · · · · · ·	PC3SF21YWZBF		PC3SF21YXPBF		PC3SF21YWPBF	В	MAX.7

■ Model Line-up (2) (Lead solder plating components)

Lead Form	Lead Form Through-Hole			SMT Gullwing Wide Through-Hole				
Shinnin a Daalta aa	Sleeve							I _{FT} [mA]
Shipping Package		Rank mark	$(V_D=4V,$					
DIN		pproved		Approved		Approved		$R_L=100\Omega$)
EN60747-5-2	A	rpproved		Appioved		Approved		
Model No.	PC3	3SF21YTZA		PC3SF21YXZA		PC3SF21YVZA	А	MAX.10
Model No.	PC3	3SF21YTZB		PC3SF21YXZB		PC3SF21YVZB	В	MAX.7

Lead Form	Lead Form Wide SMT Gullwing		SMT Gullwing Wide SMT		Γ Gullwing	Gullwing		
01 · · D I	Sleeve			Taj		I _{FT} [mA]		
Shipping Package	50pcs/sleeve		1 000pcs/reel				Rank mark	$(V_D=4V,$
DIN EN60747-5-2		Approved		Approved		Approved		$R_L=100\Omega)$
Model No.		PC3SF21YWZA		PC3SF21YXPA		PC3SF21YWPA	А	MAX.10
Model No.		PC3SF21YWZB		PC3SF21YXPB		PC3SF21YWPB	В	MAX.7

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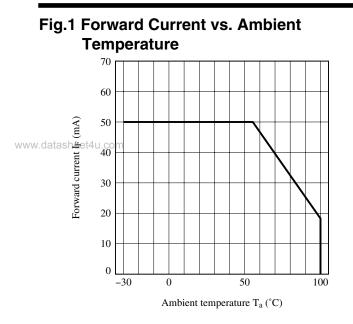
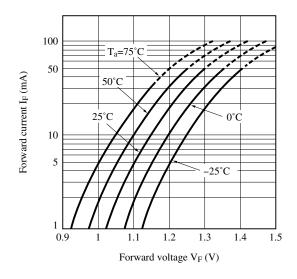


Fig.3 Forward Current vs. Forward Voltage





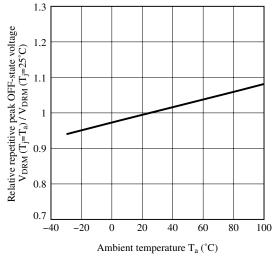


Fig.2 RMS ON-state Current vs. Ambient Temperature

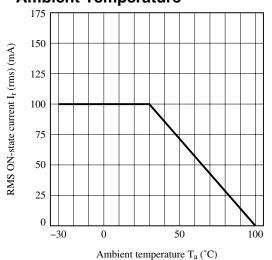


Fig.4 Minimum Trigger Current vs. Ambient Temperature

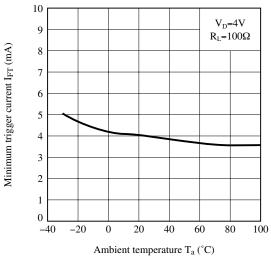
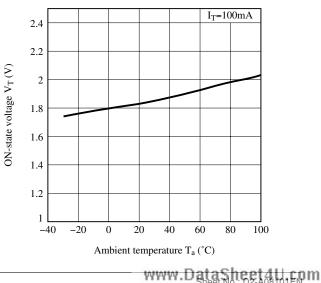


Fig.6 ON-state Voltage vs. Ambient Temperature





0.01

-20

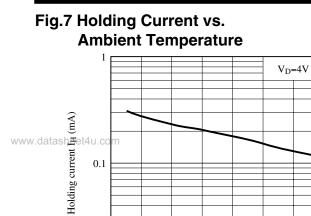


Fig.8 Repetitive Peak OFF-state Current vs. Ambient Temperature

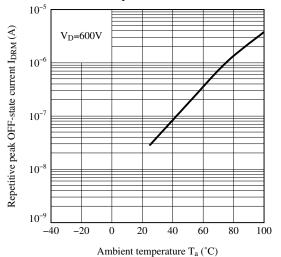


Fig.10 Zero-cross Voltage vs. Ambient Temperature

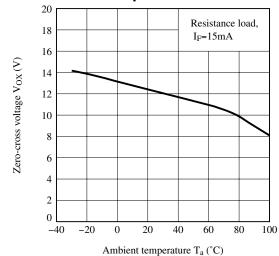


Fig.9 Turn-on Time vs. Forward Current

20

Ambient temperature Ta (°C)

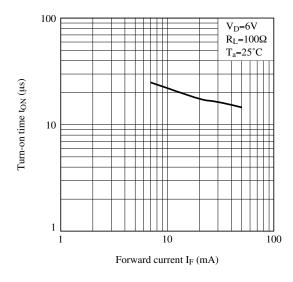
40

60

80

100

0



Remarks : Please be aware that all data in the graph are just for reference.



Design Considerations

• Design guide

In order for the Phototriac to turn off, the triggering current (I_F) must be 0.1mA or less.

Please refrain from using these devices in a direct drive configuration. These Phototriac Coupler are intended to be used as triggering device for main Triacs. Please ensure that the output rating of these www.datasheetdevices will be sufficient for triggering the main output Triac of your choice. Failure to do may result in malfunctions.

For applications with inductive loads such as motors, please use caution in utilizing a zero crossing type Phototraiac Coupler as this may cause undesired operations due to the phase difference between voltage and current of load.

For designs that will experience excessive noise or sudden changes in load voltage, please include an appropriate snubber circuit as shown in the below circuit. Please keep in mind the Sharp Phototriac Coupler incorporate superrior dV/dt ratings which can eliminate the need for a snubber circuit.

For over voltage protection, a Varistor may be used.

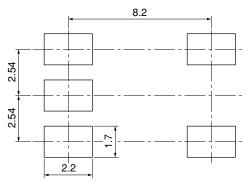
Degradation

In general, the emission of the IRED used in Phototriac Couplers will degrade over time. In the case where long term operation and / or constant extreme temperature fluctuations will be applied to the devices, please allow for a worst case scenario of 50% degradation over 5years.

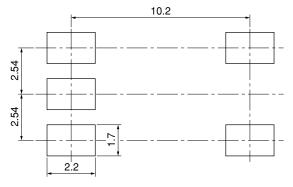
Therefore in order to maintain proper operation, a design implementing these Phototriac Couplers should provide at least twice the minimum required triggering current from initial operation.

• Recommended Foot Print (reference)

SMT Gullwing Lead-form



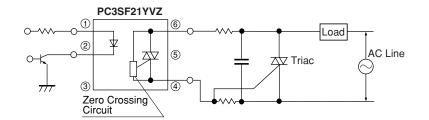
Wide SMT Gullwing Lead-form



(Unit : mm)



• Standard Circuit (Medium/High Power Triac Drive Circuit)



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Note) Please add the snubber circuit according to a condition. Any snubber or varistor used for the above mentioned scenarios should be located as close to the main output triac as possible.

☆ For additional design assistance, please review our corresponding Optoelectronic Application Notes.



Manufacturing Guidelines

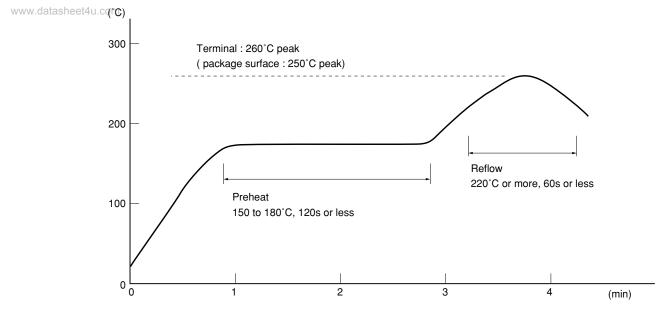
Soldering Method

Reflow Soldering:

Reflow soldering should follow the temperature profile shown below.

Soldering should not exceed the curve of temperature profile and time.

Please don't solder more than twice.



Flow Soldering :

Due to SHARP's double transfer mold construction submersion in flow solder bath is allowed under the below listed guidelines.

Flow soldering should be completed below 270°C and within 10s. Preheating is within the bounds of 100 to 150°C and 30 to 80s. Please don't solder more than twice.

Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C. Please don't solder more than twice.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



• Cleaning instructions

Solvent cleaning :

Solvent temperature should be 45°C or below. Immersion time should be 3minutes or less.

Ultrasonic cleaning :

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials :

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol.

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

• Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform) Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.



Package specification

• Sleeve package

1. Through-Hole or SMT Gullwing

Package materials

Sleeve : HIPS (with anti-static material) Stopper : Styrene-Elastomer

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Package method

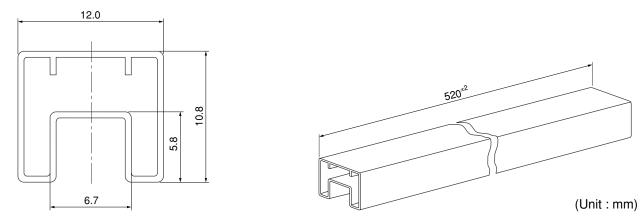
MAX. 50pcs of products shall be packaged in a sleeve.

Both ends shall be closed by tabbed and tabless stoppers.

The product shall be arranged in the sleeve with its anode mark on the tabless stopper side.

MAX. 20 sleeves in one case.

Sleeve outline dimensions



2. Wide Through-Hole or Wide SMT Gullwing

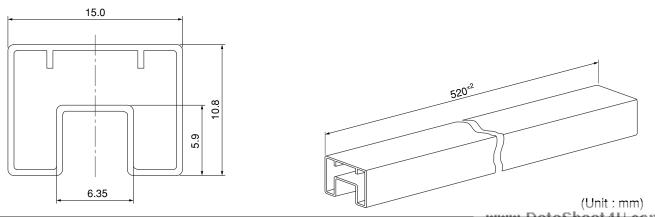
Package materials

Sleeve : HIPS (with anti-static material) Stopper : Styrene-Elastomer

Package method

MAX. 50pcs of products shall be packaged in a sleeve.Both ends shall be closed by tabbed and tabless stoppers.The product shall be arranged in the sleeve with its anode mark on the tabless stopper side.MAX. 20 sleeves in one case.

Sleeve outline dimensions



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• Tape and Reel package

1. SMT Gullwing

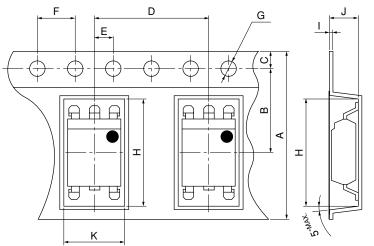
Package materials

Carrier tape : A-PET (with anti-static material)

Cover tape : PET (three layer system)

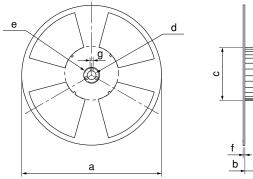
Reel : PS

Carrier tape structure and Dimensions



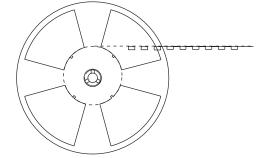
Dimensior	Dimensions List								
А	В	C	D	Е	F	G			
$16.0^{\pm 0.3}$	$7.5^{\pm0.1}$	$1.75^{\pm 0.1}$	$12.0^{\pm0.1}$	$2.0^{\pm 0.1}$	$4.0^{\pm 0.1}$	φ1.5 ^{+0.1}			
Н	Ι	J	K						
$10.4^{\pm 0.1}$	$0.4^{\pm 0.05}$	$4.2^{\pm 0.1}$	$7.8^{\pm 0.1}$						

Reel structure and Dimensions

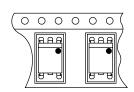


Dir	nensio	ns List	(Unit : mm)			
	а	b	с	d		
	330	$17.5^{\pm 1.5}$	$100^{\pm 1.0}$	13 ^{±0.5}		
	e	f	g			
	23 ^{±1.0}	$2.0^{\pm 0.5}$	$2.0^{\pm 0.5}$			

Direction of product insertion



Pull-out direction



[Packing : 1 000pcs/reel]



2. Wide SMT Gullwing

Package materials

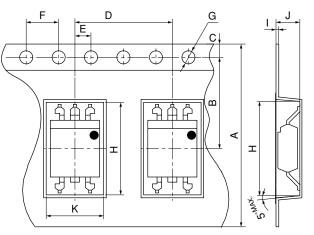
Carrier tape : A-PET (with anti-static material)

Cover tape : PET (three layer system)

Reel : PS

Carrier tape structure and Dimensions

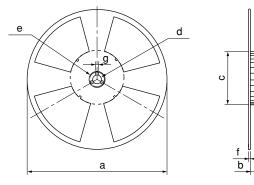
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(Unit : mm)

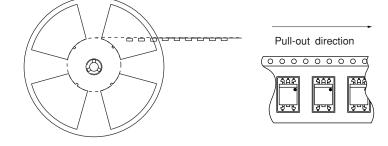
Dimensior	Dimensions List (Unit : mm)								
А	В	C	D	Е	F	G			
24.0 ^{±0.3}	$11.5^{\pm 0.1}$	$1.75^{\pm 0.1}$	$12.0^{\pm0.1}$	$2.0^{\pm 0.1}$	$4.0^{\pm 0.1}$	φ1.5 ^{+0.1}			
Н	Ι	J	K						
$12.2^{\pm 0.1}$	$0.4^{\pm 0.05}$	$4.15^{\pm0.1}$	$7.6^{\pm 0.1}$						

Reel structure and Dimensions



Dimensio	ns List	(Unit : mm)			
а	b	с	d		
330	25.5 ^{±1.5}	$100^{\pm 1.0}$	13 ^{±0.5}		
e	f	g			
23 ^{±1.0}	2.0 ^{±0.5}	$2.0^{\pm 0.5}$			

Direction of product insertion



[Packing: 1 000pcs/reel]

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- --- Office automation equipment
- --- Telecommunication equipment [terminal]
- --- Test and measurement equipment
- --- Industrial control
- --- Audio visual equipment
- --- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:

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- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.

(iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

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